HALOGEN

FREE



Vishay Siliconix

Low Voltage, 0.6 Ω , Dual SPDT Analog Switch

DESCRIPTION

The DG2735A is low voltage, low on-resistance, dual singlepole/double-throw (SPDT) monolithic CMOS analog switches designed for high performance switching of analog signals. Combining low-power, high speed, low on-resistance, and small package size, the DG2735A is ideal for portable and battery power applications.

The DG2735A have an operation range from 1.65 V to 4.3 V single supply. The DG2735A has two separate control pins with for the separated two SPDT switched.

The DG2735A is guaranteed 1.65 V logic compatible, allowing the easy interface with low voltage DSP or MCU control logic and ideal for one cell Li-ion battery direct power.

The switch conducts signals within power rails equally well in both directions when on, and blocks up to the power supply level when off. Break-before-make is guaranteed.

The DG2735A is built on Vishav Siliconix's sub micron CMOS low voltage process technology and provides greater than 300 mA latch-up protection, as tested per JESD78.

As a committed partner to the community and the environment, Vishay Siliconix manufactures this product with lead (Pb)-free device terminations. DG2735A is offered in a miniQFN package. The miniQFN package has a nickelpalladium-gold device termination and is represented by the lead (Pb)-free "-E4" suffix. The nickel-palladium-gold device terminations meet all JEDEC standards for reflow and MSL ratings.

FEATURES

- Low voltage operation (1.65 V to 4.3 V)
- Low on-resistance R_{ON} : 0.6 Ω at 2.7 V
- Fast switching: t_{ON} = 64 ns at 2.7 V $t_{OFF} = 42 \text{ ns at } 2.7 \text{ V}$
- Latch-up current > 300 mA (JESD78)





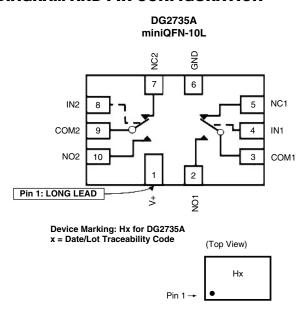
BENEFITS

- Reduced power consumption
- High accuracy
- Reduce board space
- TTL/1.65 V logic compatible

APPLICATIONS

- · Cellular phones
- Speaker headset switching
- Audio and video signal routing
- PCMCIA cards
- Battery operated systems
- Portable media player handheld test instruments

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



Note: Pin 1 has long lead



TRUTH TABLE						
Logic	NC	NO				
0	ON	OFF				
1	OFF	ON				

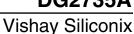
ORDERING INFORMATION							
Temp. Range	Part Number						
- 40 °C to 85°C	miniQFN10	DG2735ADN-T1-GE4					

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Deference to CND	V+		- 0.3 to 5.0	V		
Reference to GND	IN, COM, NC, NO ^a		- 0.3 to (V+ + 0.3)	¬		
Current (Any terminal except NO, NO	C or COM)		30			
Continuous Current (NO, NC, or COM)		± 250		mA		
Peak Current (Pulsed at 1 ms, 10 % duty cycle)			± 500			
Storage Temperature (D Suffix)			- 65 to 150	°C		
Power Dissipation (Packages) ^b	miniQFN10 ^c		208	mW		

Notes:

- a. Signals on NC, NO, or COM or IN exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- b. All leads welded or soldered to PC board.
- c. Derate 4.0 mW/C above 70 °C.

SPECIFICATIONS (V+ = 3 V)								
		Test Conditions Unless Otherwise Specified		Limits - 40 °C to 85 °C				
Parameter	Symbol					Max.b	Unit	
Analog Switch								
Analog Signal Range ^d	V _{ANALOG}	r _{DS(on)}	Full	0		V+	V	
		$V+ = 2.7 \text{ V}, I_{NO/NC} = 100 \text{ mA}, V_{COM} = 0.5 \text{ V}$	Room		0.5	0.6		
		$V+ = 2.7 \text{ V}, I_{NO/NC} = 100 \text{ mA}, V_{COM} = 1.5 \text{ V}$	HOOIII		0.5			
		$V+ = 2.7 \text{ V}, I_{NO/NC} = 100 \text{ mA}, V_{COM} = 0.5 \text{ V}$	Full		0.6			
On-Resistance	B	$V+ = 2.7 \text{ V}, I_{NO/NC} = 100 \text{ mA}, V_{COM} = 1.5 \text{ V}$	i uli		0.0			
On resistance	R _{DS(on)}	$V+ = 4.3 \text{ V}, I_{NO/NC} = 100 \text{ mA}, V_{COM} = 0.9 \text{ V}$	Room		0.4	0.5		
		$V+ = 4.3 \text{ V}, I_{NO/NC} = 100 \text{ mA}, V_{COM} = 2.5 \text{ V}$	1100111		0.4			
		$V+ = 4.3 \text{ V}, I_{NO/NC} = 100 \text{ mA}, V_{COM} = 0.9 \text{ V}$	Full		0.4		Ω	
		$V+ = 4.3 \text{ V}, I_{NO/NC} = 100 \text{ mA}, V_{COM} = 2.5 \text{ V}$	1 411		0.1			
	ΔR _{ON}	$V + = 2.7 \text{ V}, I_{NO/NC} = 100 \text{ mA},$			0.06	0.08		
R _{ON} Match ^d		V _{COM} = 0.5 V, 1.5 V	Room					
		$V+ = 4.3 \text{ V}, I_{NO/NC} = 100 \text{ mA},$ $V_{COM} = 0.9 \text{ V}, 2.5 \text{ V}$						
	R _{ON}	$V_{COM} = 0.0 \text{ V}, 2.0 \text{ V}$ $V_{T} = 2.7 \text{ V}, I_{NO/NC} = 100 \text{ mA},$						
R _{ON} resistance flatness ^d	flatness	$V_{COM} = 0.5 \text{ V}, 1.5 \text{ V}$	Room			0.15		
	I _{NO/NC(off)}		Room	- 10		10		
Switch Off Leakage		$V + = 4.3 \text{ V}, V_{NO/NC} = 0.3 \text{ V}/4.0 \text{ V},$	Full	- 50		50		
Current		$V_{COM} = 4.0 \text{ V}/0.3 \text{ V}$	Room	- 10		10	nA	
				- 50		50	11/4	
Channel-On Leakage	laa	$V + = 4.3 \text{ V}, V_{NO/NC} = V_{COM} = 4.0 \text{ V}/0.3 \text{ V}$	Room	- 20		20		
Current		V+ = 4.0 V, VNO/NC = VCOM = 4.0 V/0.0 V	Full	- 100		100		
Digital Control								
Input High Voltage	V _{INH}		Full	1.65			V	
Input Low Voltage	V_{INL}		Full			0.4	•	
Input Capacitance	C _{IN}		Full		6		pF	
Input Current	I _{INL} or I _{INH}	$V_{IN} = 0$ or $V+$	Full	- 1		1	μΑ	



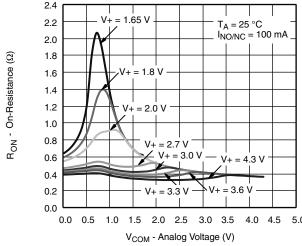


SPECIFICATIONS (V+ = 3 V)							
		Test Conditions Unless Otherwise Specified		Limits - 40 °C to 85 °C			
Parameter	Symbol	$V+ = 3 V, \pm 10 \%, V_{IN} = 0.4 V \text{ or } 1.65 V^{e}$	Temp. ^a	Min. ^b	Typ.c	Max.b	Unit
Dynamic Characteristics							
Break-Before-Make Time ^e	t _{BBM}		Room	1	11		ns
Turn-On Time ^e	t _{ON}	V: 26VV V 15VD 500	Room		44	75	
Turn-Ori Time		$V+ = 3.6 \text{ V}, V_{NO}, V_{NC} = 1.5 \text{ V}, R_L = 50 \Omega,$ $C_1 = 35 \text{ pF}$	Full			80	
Turn-Off Time ^e	+	- Ο[– 35 μι	Room		26	55	
Turn-Off Time	t _{OFF}		Full			60	
Off-Isolation ^d	O _{IRR}	P - 50 0 C - 5 x 5 f - 100 kHz	Room	Doom	- 70		dB
Crosstalk ^d	X _{TALK}	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 100 kHz$	HOOIII		- 70		
3dB bandwith ^d		$R_L = 50 \Omega, C_L = 5 pF$	Room		30		MHz
NO, NC Off Capacitance ^d	C _{NO(off)}		Room		52		pF
NO, NO OII Capacitance	C _{NC(off)}	\			52		
Channel On Canacitanced	C _{NO(on)}	$V_{IN} = 0 \text{ V, or V+, f} = 1 \text{ MHz}$			168		
Channel On Capacitance ^d	C _{NC(on)}				168		
Power Supply							
Power Supply Range	V+			1.65		4.3	V
Power Supply Current	l+	V _{IN} = 0 or V+	Full			1.0	μΑ

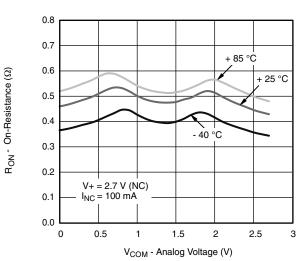
- a. Room = 25 °C, Full = as determined by the operating suffix.
- b. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- c. Typical values are for design aid only, not guaranteed nor subject to production testing.
- d. Guarantee by design, not subjected to production test.
- e. V_{IN} = input voltage to perform proper function.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

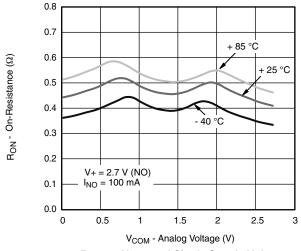




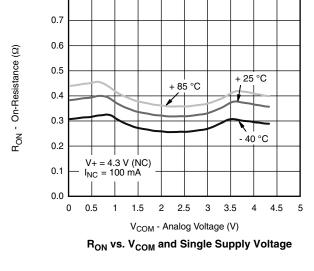


R_{ON} vs. V_{COM} and Single Supply Voltage

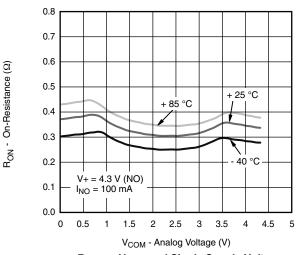
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



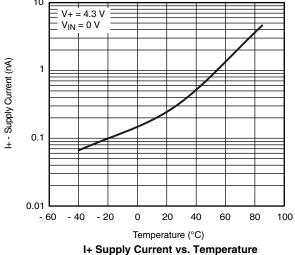
 R_{ON} vs. V_{COM} and Single Supply Voltage

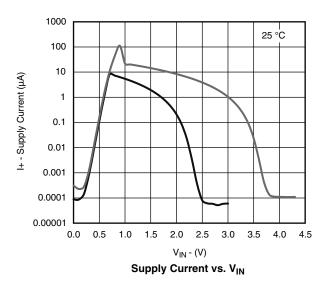


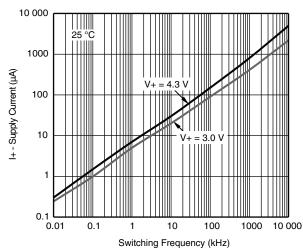
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 R_{ON} vs. V_{COM} and Single Supply Voltage





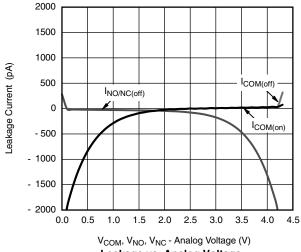


Supply Current vs. Switching Frequency

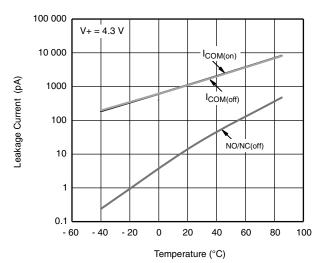




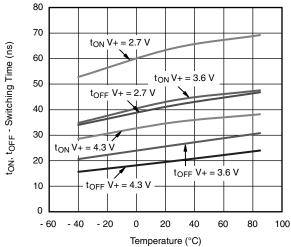
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



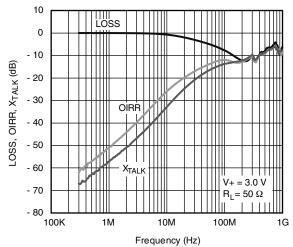
Leakage vs. Analog Voltage



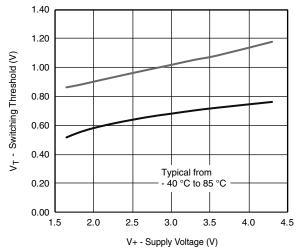
Leakage Current vs. Temperature



Switching Time vs. Temperature

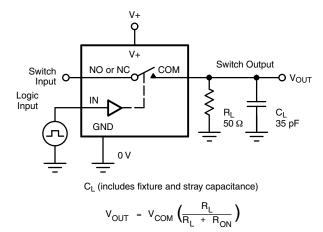


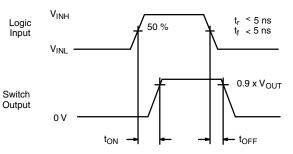
Insertion Loss, Off-Isolation Crosstalk vs. Frequency



Switching Threshold vs. Supply Voltage

TEST CIRCUITS





Logic "1" = Switch On Logic input waveforms inverted for switches that have the opposite logic sense.

Figure 1. Switching Time

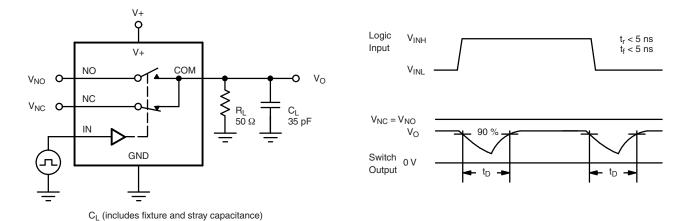
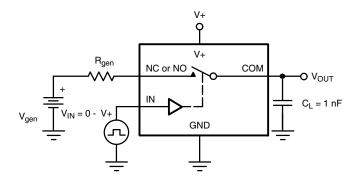
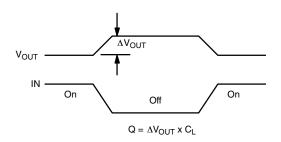


Figure 2. Break-Before-Make Interval



TEST CIRCUITS





IN depends on switch configuration: input polarity determined by sense of switch.

Figure 3. Charge Injection

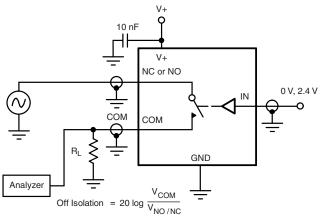


Figure 4. Off-Isolation

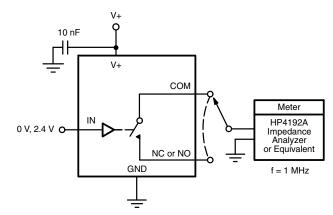
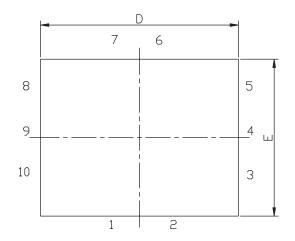
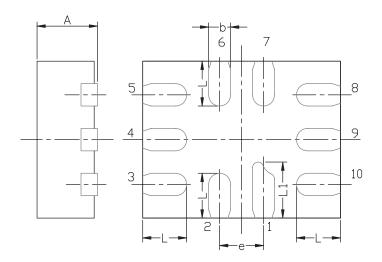


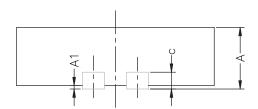
Figure 5. Channel Off/On Capacitance

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67590.

MINI QFN-10L CASE OUTLINE







DIM	M	IILLIMETER	S	INCHES			
	MIN.	NAM.	MAX.	MIN.	NAM.	MAX.	
Α	0.50	0.55	0.60	0.0197	0.0217	0.0236	
A1	0.00	-	0.05	0.000	-	0.002	
b	0.15	0.20	0.25	0.006 0.008 0.01			
С	0.15 REF			0.006 REF			
D	1.75	1.80	1.85	0.069 0.071 0.07		0.073	
E	1.35	1.40	1.45	0.053	0.055	0.057	
е		0.40 BSC		0.016 BSC			
L	0.35	0.40	0.45	0.014	0.016	0.018	
L1	0.45	0.50	0.55	0.0177	0.0197	0.0217	

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DWG: 5957





Vishay

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